# **Ultra Field Stop IGBT,** 1200 V, 60 A

#### **General Description**

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

## Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature  $T_J = 175^{\circ}C$
- Low Saturation Voltage:  $V_{CE(sat)} = 1.7 V (Typ.) @ I_C = 60 A$
- 100% of the Parts Tested for I<sub>LM</sub> (Note 1)
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- RoHS Compliant

### Applications

• Solar Inverter, UPS

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25°C unless otherwise noted)					
Symbol	Description	Value	Unit		
V <sub>CES</sub>	Collector to Emitter Voltage	1200	V		
V <sub>GES</sub>	Gate to Emitter Voltage	±25	V		
	Transient Gate to Emitter Voltage	±30	V		
Ι <sub>C</sub>	Collector Current @ (T <sub>C</sub> = 25°C)	120	А		
	Collector Current @ (T <sub>C</sub> = 100°C)	60	А		
I <sub>LM</sub> (1)	Pulsed Collector Current @ (T <sub>C</sub> = 25°C)	240	А		
I <sub>CM</sub> (2)	Pulsed Collector Current	240	А		
١ <sub>F</sub>	Diode Forward Current @ ( $T_C = 25^{\circ}C$ )	120	А		
	Diode Forward Current @ (T <sub>C</sub> =100°C)	60	А		
I <sub>FM</sub>	Pulsed Diode Max. Forward Current	240	А		
PD	Maximum Power Dissipation	<b>547</b>	W		
	@ (T <sub>C</sub> = 25°C) @ (T <sub>C</sub> =100°C)	517 259	W		
TJ	Operating Junction Temperature	on Temperature -55 to +175			
T <sub>stg</sub>	Storage Temperature Range	–55 to +175	°C		
TL	Maximum Lead Temp. For soldering Purposes, 1/8" from case for 5 seconds	300	°C		

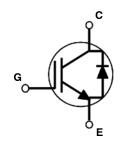
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. VCC = 800 V, V<sub>GE</sub> = 15 V, I<sub>C</sub> = 240 A,  $\dot{R}_{G}$  = 68  $\Omega$ , Inductive Load 2. Repetitive rating: Pulse width limited by max. Junction temperature



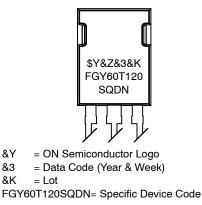
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#### MARKING DIAGRAM



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#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 3 of this data sheet.

#### THERMAL CHARACTERISTICS

Symbol	Parameter	FGY60T120SQDN	Unit
R <sub>0JC</sub> (IGBT)	Thermal Resistance, Junction to Case, Max.	0.29	°C/W
$R_{\theta JA}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.42	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$V_{GE}$ = 0V, I <sub>C</sub> = 500 $\mu$ A	1200	-	-	V
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	400	μΑ
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±200	nA
ON CHARAC	CTERISTICS					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_C$ = 400 $\mu$ A, $V_{CE}$ = $V_{GE}$	4.5	5.5	6.5	V
. ,		I <sub>C</sub> = 60 A <sub>,</sub> V <sub>GE</sub> = 15 V	-	1.7	1.95	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{C} = 60 \text{ A}, \text{ V}_{GE} = 15 \text{ V}, \text{ T}_{C} = 175^{\circ}\text{C}$	_	2.3	-	v
	HARACTERISTICS		+	4		1
C <sub>ies</sub>	Input Capacitance		-	7147	-	pF
C <sub>oes</sub>	Output Capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	-	203	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance		-	114	-	pF
SWITCHING	CHARACTERISTICS	•				
t <sub>d(on)</sub>	Turn-On Delay Time		-	52	-	ns
t <sub>r</sub>	Rise Time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 60 \text{ A}, \text{ R}_{G} = 10 \Omega,$	-	84	-	ns
td(off)	Turn-Off Delay Time	V <sub>GE</sub> = 15 V,	-	296	-	ns
t <sub>f</sub>	Fall Time	Inductive Load, $T_C = 25^{\circ}C$	-	56	-	ns
Eon	Turn-On Switching Loss		-	5.15	-	mJ
Eoff	Turn–Off Switching Loss		-	1.82	-	mJ
Ets	Total Switching Loss		-	6.97	-	mJ
td(on)	Turn-On Delay Time		-	40	-	ns
tr	Rise Time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 60 \text{ A}, \text{ R}_{G} = 10 \Omega,$	-	72	-	ns
td(off)	Turn-Off Delay Time	V <sub>GE</sub> = 15 V,	-	324	-	ns
t <sub>f</sub>	Fall Time	Inductive Load, T <sub>C</sub> = 175°C	-	144	-	ns
Eon	Turn-On Switching Loss		-	7.18	-	mJ
Eoff	Turn-Off Switching Loss		-	3.1	-	mJ
Ets	Total Switching Loss		-	10.28	-	mJ
Qg	Total Gate Charge		-	311	-	nC
Qge	Gate to Emitter Charge	$V_{CE} = 600 \text{ V}, \text{ I}_{C} = 60 \text{ A}, \text{ V}_{GE} = 15 \text{ V}$	_	57	-	nC
Qgc	Gate to Collector Charge	1	-	153	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

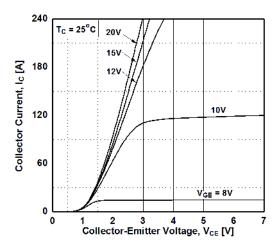
#### Symbol Parameter **Test Condition** Min. Тур. Max. Unit $T_C = 25^{\circ}C$ 3.4 4 \_ $I_{F} = 60 \text{ A}$ $\mathsf{V}_{\mathsf{FM}}$ Diode Forward Voltage V $T_C = 175^{\circ}C$ 3.2 -- $T_C = 25^{\circ}C$ 91 \_ \_ Diode Reverse Recovery Time t<sub>rr</sub> ns $T_C = 175^{\circ}C$ 309 \_ \_ $\begin{array}{l} V_R = 600 \text{ V}, \\ I_F = 60 \text{ A}, \\ dI_F/dt = 500 \text{ A}/\mu\text{s} \end{array} \end{array}$ $T_C = 25^{\circ}C$ 860 \_ \_ $\mathsf{Q}_{\mathsf{rr}}$ nC Diode Reverse Recovery Charge $T_C = 175^{\circ}C$ \_ 4902 \_ $T_C = 25^{\circ}C$ 19 \_ \_ I<sub>rrm</sub> А Diode Reverse Recovery Current $T_C = 175^{\circ}C$ 32 \_ \_

# **ELECTRICAL CHARACTERISTICS OF THE DIODE** ( $T_C = 25^{\circ}C$ unless otherwise noted)

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Quantity
FGY60T120SQDN	FGY60T120SQDN	TO-247-3LD (Pb-Free)	30/Tube

### **TYPICAL PERFORMANCE CHARACTERISTICS**



**Figure 1. Typical Output Characteristics** 

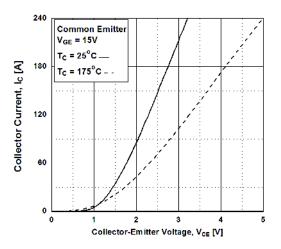


Figure 3. Typical Saturation Voltage Characteristics

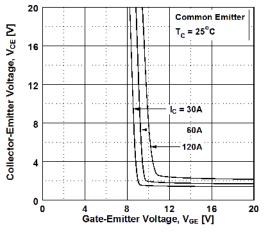
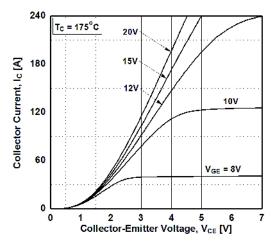


Figure 5. Saturation Voltage vs.  $V_{GE}$ 



**Figure 2. Typical Output Characteristics** 

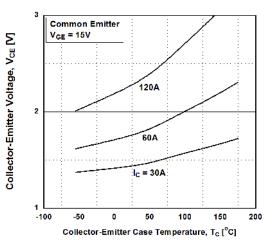


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

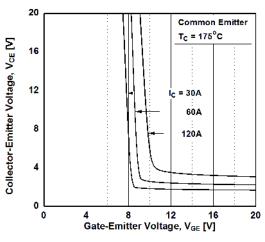
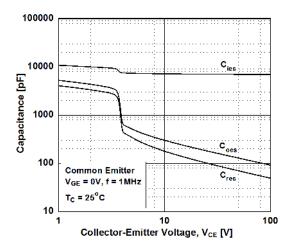


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

#### **TYPICAL PERFORMANCE CHARACTERISTICS**





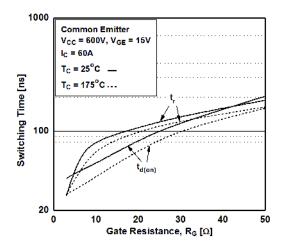


Figure 9. Turn-on Characteristics vs. Gate Resistance

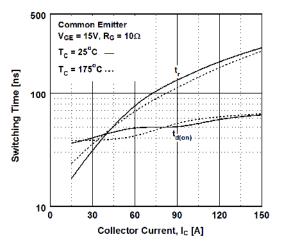


Figure 11. Turn-on Characteristics vs. Collector Current

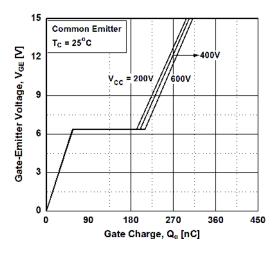


Figure 8. Gate charge Characteristics

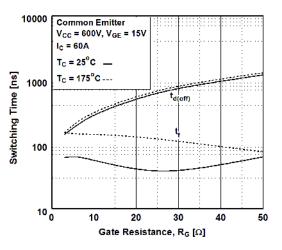


Figure 10. Turn-off Characteristics vs. Gate Resistance

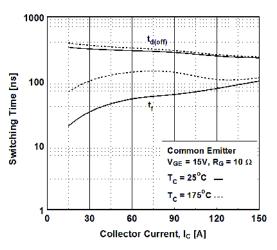
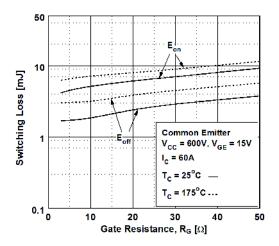
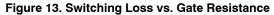


Figure 12. Turn-off Characteristics vs. Collector Current

## **TYPICAL PERFORMANCE CHARACTERISTICS**





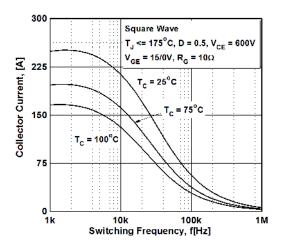


Figure 15. Load Current vs. Frequency

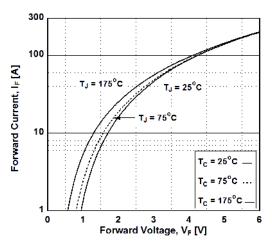


Figure 17. Forward Characteristics

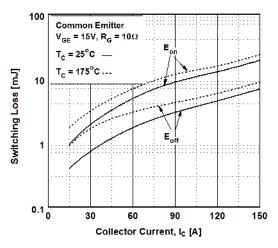
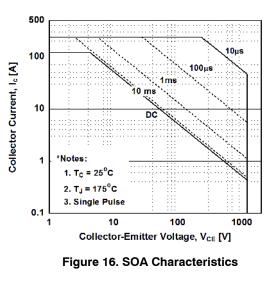


Figure 14. Switching Loss vs. Collector Current



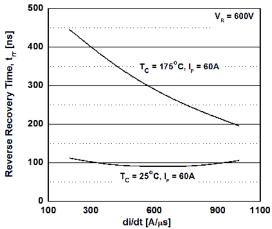


Figure 18. Reverse Recovery Time vs. di<sub>F</sub>/dt

## **TYPICAL PERFORMANCE CHARACTERISTICS**

60

50

40

30

20

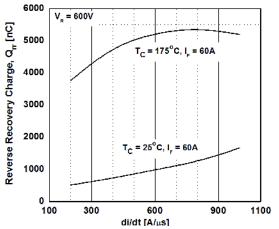
10

0

Reverse Recovery Current,  $I_{\pi}$  [A]

V<sub>R</sub> = 600V

T<sub>C</sub> = 175°C, I<sub>e</sub> = 60A



600 900 1100 100 300 /dt [A/⊭s]

Figure 19. Reverse Recovery Charge vs.  $\mathrm{di}_\mathrm{F}/\mathrm{dt}$ 



600

 $T_{C} = 25^{\circ}C, I_{F} = 60A$ 

1100

900

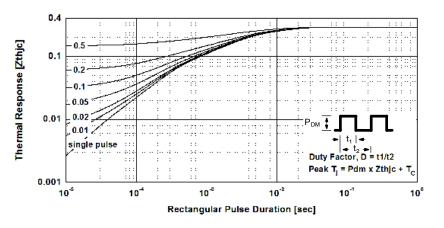


Figure 21. Transient Thermal Impedance if IGBT

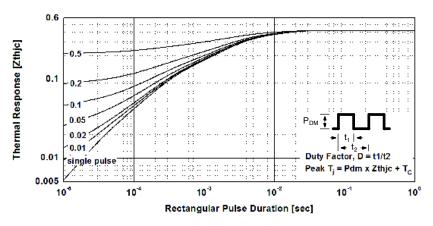
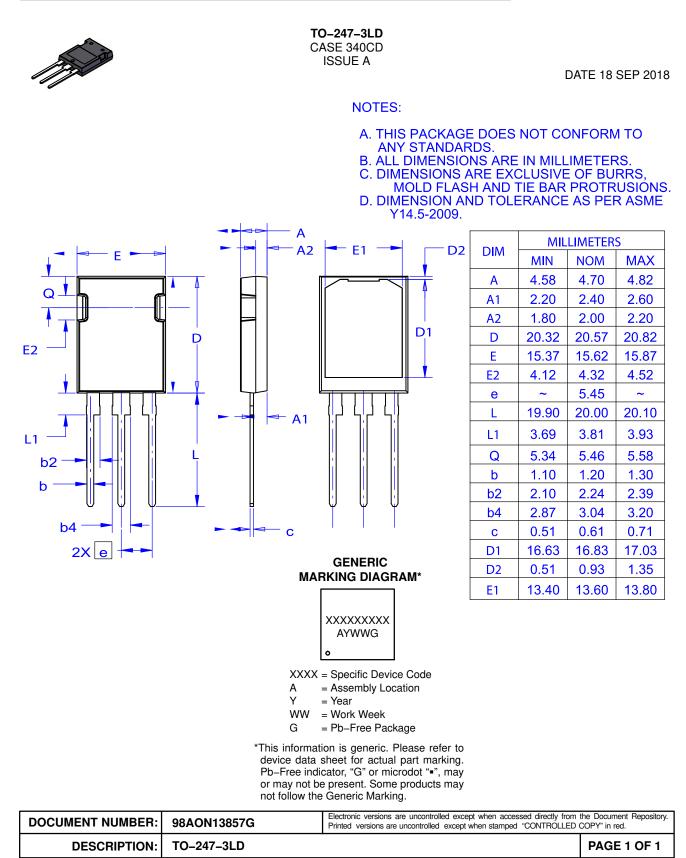


Figure 22. Transient Thermal Impedance if Diode





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